



MATERIAL
 HOUSING : HIGH TEMPERATURE HOUSING
 LCP (UL94V-0)WITHSTANDS IR AND
 VPR SOLDERING METHODS.
 CONTACTS : BRONZE.
 PLATING : SELECTIVE GOLD PLATED.

SPECIFICATION
 CURRENT RATING : 1AMP.
 INSULATOR RESISTANCE 5000MΩ MIN. AT DC 500V.
 CONTACT RESISTANCE : 20MΩ MAX. AT DC 100mA.
 OPERATING TEMPERATURE : -65°C~+125°C.
 MAX PROCESSING TEMPERATURE: 260±10°C FOR 3~5 SECONDS.

RoHS Compliant		HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准 HELEN		TOLERANCE 容許公差 0 ± 0.35 .00 ± 0.25 ANG. ± 3°	PART NAME 品名 D-SUB PCB R/A FOR NOTEBOOK SMT TYPE 9P MALE THREAD INSERT 4-40UNC W/BOARDLOCK W/O SCREWS NICKEL SHELL+DIMPLE SELECTIVE GOLD PLATING BLACK COLOR MATERIAL:LCP POST SPACING=15.9mm ROHS
DWG. 製圖 ABBY	SCALE 比例 參考	UNIT 單位 MM	PART NO. 料號 C0527-09MBABSBN
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